

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT6659992

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
HYUK WON	04/12/2021
RECEIVING PARTY DATA	
Name:	EM-TECH CO., LTD.
Street Address:	40 CHANGWONDAERO 1144 BEON-GIL, SEONGSAN-GU
Internal Address:	CHANGWON-SI
City:	GYEONGSANGNAM-DO
State/Country:	KOREA, REPUBLIC OF
Postal Code:	51539
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17220314
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	9199483390
Email:	OFFICIAL@MBHIPLAW.COM
Correspondent Name:	MURPHY, BILAK & HOMILLER, PLLC
Address Line 1:	1255 CRESCENT GREEN, SUITE 200
Address Line 4:	CARY, NORTH CAROLINA 27518
ATTORNEY DOCKET NUMBER:	1050-0115 / FP21203/US
NAME OF SUBMITTER:	MARK R. BILAK
SIGNATURE:	/Mark R. Bilak, Reg. No. 47,423/
DATE SIGNED:	04/16/2021
Total Attachments: 1	
source=1050-0115 Assignment, signed#page1.tif	

ASSIGNMENT

This Assignment is made by:

Hyuk Won

107, 10, Sujeonggongwon-ro, Dong-gu
Busan, 48712
Republic of Korea

hereinafter individually or collectively referred to as "Assignor";

hereby sell, assign and transfer to EM-TECH Co., Ltd., having its principal place of business at

40 Changwondaero 1144 beon-gil, Seongsan-gu
Changwon-si
Gyeongsangnam-do, 51539
Republic of Korea

hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

filed on: April 1, 2021 as US Serial No: 17/220,314

entitled: Sound Converting Device having Near-Infrared Ray Emission Function

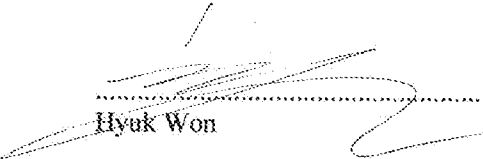
and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: 2021/04/12

Signature of Assignor


Hyuk Won